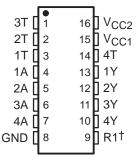
SLLS083B - NOVEMBER 1970 - REVISED MAY 1995

- Meets or Exceeds the Requirements of ANSI Standard EIA/TIA-232-E and ITU Recommendation V.28
- Input Resistance . . . 3 k Ω to 7 k Ω Over Full EIA/TIA-232-E Voltage Range
- Input Threshold Adjustable to Meet Fail-Safe Requirements Without Using External Components
- Built-In Hysteresis for Increased Noise Immunity
- Inverting Output Compatible With TTL
- Output With Active Pullup for Symmetrical Switching Speeds
- Standard Supply Voltages . . . 5 V or 12 V

D OR N PACKAGE (TOP VIEW)



† For function of R1, see schematic

description

The SN75154 is a monolithic low-power Schottky line receiver designed to satisfy the requirements of the standard interface between data terminal equipment and data communication equipment as defined by ANSI Standard EIA/TIA-232-E. Other applications are for relatively short, single-line, point-to-point data transmission and for level translators. Operation is normally from a single 5-V supply; however, a built-in option allows operation from a 12-V supply without the use of additional components. The output is compatible with most TTL circuits when either supply voltage is used.

In normal operation, the threshold-control terminals are connected to the V_{CC1} terminal, even if power is being supplied via the alternate V_{CC2} terminal. This provides a wide hysteresis loop, which is the difference between the positive-going and negative-going threshold voltages. See typical characteristics. In this mode of operation, if the input voltage goes to zero, the output voltage will remain at the low or high level as determined by the previous input.

For fail-safe operation, the threshold-control terminals are open. This reduces the hysteresis loop by causing the negative-going threshold voltage to be above zero. The positive-going threshold voltage remains above zero as it is unaffected by the disposition of the threshold terminals. In the fail-safe mode, if the input voltage goes to zero or an open-circuit condition, the output will go to the high level regardless of the previous input condition.

The SN75154 is characterized for operation from 0°C to 70°C.



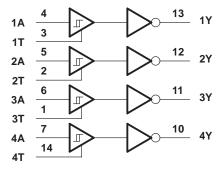
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



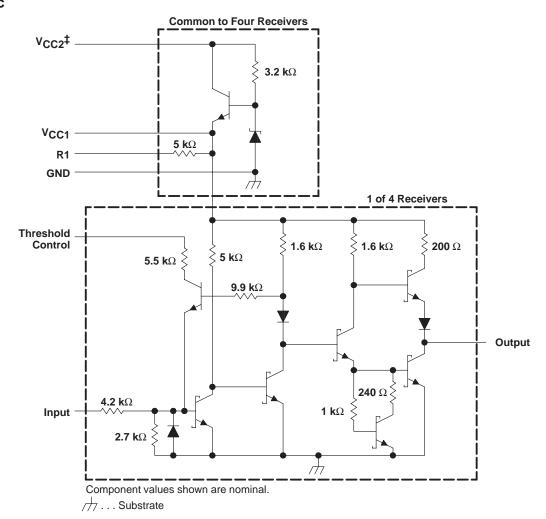
logic symbol†

1A 13 1T THRS ADJ 5 2A 12 2 2Y **2T** 6 3A 11 **3Y 3T** 7 4A 10 4Y 14 4T

logic diagram (positive logic)



schematic



[‡] When V_{CC1} is used, V_{CC2} may be left open or shorted to V_{CC1}. When V_{CC2} is used, V_{CC1} must be left open or connected to the threshold control pins.



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Normal supply voltage, V _{CC1} (see Note 1)	7 V
Alternate supply voltage, V _{CC2}	14 V
Input voltage, V _I	±25 V
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, T _A	0°C to 70°C
Storage temperature range, T _{stq}	65°C to 150°C
- 3	260°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

DISSIPATION RATING TABLE

	PACKAGE	$T_{\mbox{A}} \le 25^{\circ}\mbox{C}$ POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING
l	D	950 mW	7.6 mW/°C	608 mW
ı	N	1150 mW	9.2 mW/°C	736 mW
	NS	625 mW	5.0 mW/°C	400 mW

recommended operating conditions

	MIN	NOM	MAX	UNIT
Normal supply voltage, V _{CC1}	4.5	5	5.5	V
Alternate supply voltage, V _{CC2}	10.8	12	13.2	V
High-level input voltage, V _{IH} (see Note 2)	3		15	V
Low-level input voltage, V _{IL} (see Note 2)	-15		-3	V
High-level output current, IOH			-400	μΑ
Low-level output current, IOL			16	mA
Operating free-air temperature, T _A	0		70	°C

NOTE 2: The algebraic convention, where the less positive (more negative) limit is designated as minimum, is used in this data sheet for logic and threshold levels only, e.g., when 0 V is the maximum, the minimum limit is a more negative voltage.



NOTE 1: Voltage values are with respect to network GND terminal.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST FIGURE	TEST COND	ITIONS	MIN	TYP	MAX	UNIT
\/	Positive-going input	Normal operation	1	,		0.8	2.2	3	V
V _{IT+}	threshold voltage	Fail-safe operation	'			0.8	2.2	3	v
\/	Negative-going input	Normal operation	1			-3	-1.1	0	V
VIT-	threshold voltage	Fail-safe operation	'			0.8	1.4	3	V
٧,	Hysteresis voltage	Normal operation	1			0.8	3.3	6	V
V _{hys}	$(V_{IT+} - V_{IT-})$	Fail-safe operation	'			0	0.8	2.2	v
Vон	High-level output voltage		1	I _{OH} = -400 μA	2.4	3.5		V	
VOL	Low-level output voltage		1	I _{OL} = 16 mA		0.29	0.4	V	
				$\Delta V_{ } = -25 \text{ V to } -1$	4 V	3	5	7	
				$\Delta V_{ } = -14 \text{ V to } -3$	V	3	5	7	
rį	Input resistance		2	$\Delta V_{I} = -3 \text{ V to } 3 \text{ V}$		3	6	8	kΩ
				$\Delta V_I = 3 \text{ V to } 14 \text{ V}$		3	5	7	11.22
			$\Delta V_{\parallel} = 14 \text{ V to } 25 \text{ V}$	1	3	5	7		
V _{I(open)}	Open-circuit input voltage	3	I _I = 0		0	0.2	2	V	
los	Short-circuit output current [‡]			$V_{CC1} = 5.5 \text{ V},$	$V_{I} = -5 V$	-10	-20	-40	mA
I _{CC1}	Supply current from V _{CC1}		5	$V_{CC1} = 5.5 \text{ V},$	T _A = 25°C		20	35	m A
I _{CC2}	Supply current from V _{CC2}			V _{CC2} = 13.2 V,	T _A = 25°C		23	40	mA

switching characteristics, V_{CC1} = 5 V, T_A = 25°C, N = 10

	PARAMETER	TEST FIGURE	TEST CO	NDITIONS	MIN	TYP	MAX	UNIT
tPLH	Propagation delay time, low- to high-level output					11		ns
tPHL	Propagation delay time, high- to low-level output	6	$C_1 = 50 pF$	$R_1 = 390 \Omega$		8		ns
tTLH	Transition time, low- to high-level output		C[= 50 pr,	KL = 390 12		7		ns
tTHL	Transition time, high- to low-level output					2.2		ns



[†] All typical values are at V_{CC1} = 5 V, T_A = 25°C. ‡ Not more than one output should be shorted at a time.

TYPICAL CHARACTERISTICS

OUTPUT VOLTAGE INPUT VOLTAGE V_{CC1} = 5 V V_O - Output Voltage - V T_A = 25°C Normal Operation Fail-Safe Operation VIT-V_{IT+} VIT-See Note A 2 -25 -3 -2 -1 3 25 V_I - Input Voltage - V

NOTE A: For normal operation, the threshold controls are connected to $V_{\rm CC1}$. For fail-safe operation, the threshold controls are open.

Figure 1

PARAMETER MEASUREMENT INFORMATION

dc test circuits†

TEST TABLE

TEST	MEASURE	Α	Т	Y	V _{CC1}	V _{CC2}
Open-circuit input (fail safe)	Voн	Open	Open	IOH	4.5 V	Open
Open-circuit input (fail safe)	Voн	Open	Open	IOH	Open	10.8 V
V _{IT+} min, V _{IT-} min (fail safe)	Voн	0.8 V	Open	IOH	5.5 V	Open
	Voн	0.8 V	Open	IOH	Open	13.2 V
V— min (normal)	Voн	Note A	V _{CC1}	IOH	5.5 V and T	Open
V _{IT+} min (normal)	Voн	Note A	V _{CC1}	IOH	Т	13.2 V
Viv. may Vi= min (normal)	Voн	-3 V	V _{CC1}	I _{OH}	5.5 V and T	Open
V _{IL} max, V _{IT+} min (normal)	Vон	-3 V	V _{CC1}	loH	Т	13.2 V
Vu min Vi may Vi may (fail acta)	VoL	3 V	Open	loL	4.5 V	Open
V _{IH} min, V _{IT+} max, V _{IT-} max (fail safe)	VoL	3 V	Open	loL	Open	10.8 V
Vu min Vi may (narmal)	VoL	3 V	V _{CC1}	loL	4.5 V and T	Open
V _{IH} min, V _{IT+} max (normal)	VOL	3 V	V _{CC1}	loL	Т	10.8 V
Vi- max (normal)	VoL	Note B	VCC1	loL	5.5 V and T	Open
V _{IT} max (normal)	VOL	Note B	V _{CC1}	loL	T	13.2 V

NOTES: A. Momentarily apply -5 V, then 0.8 V.

B. Momentarily apply 5 V, then GND.

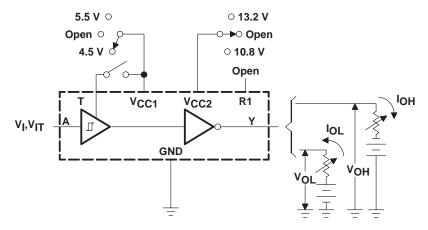
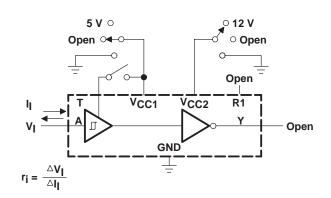


Figure 2. V_{IH}, V_{IL}, V_{IT+}, V_{IT-}, V_{OH}, V_{OL}

[†] Arrows indicate actual direction of current flow. Current into a terminal is a positive value.

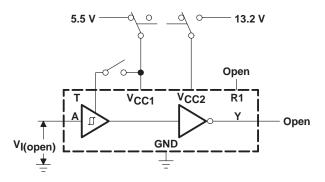
PARAMETER MEASUREMENT INFORMATION

dc test circuits† (continued)



	TEST TABLE										
Т	V _{CC1}	V _{CC2}									
Open	5 V	Open									
Open	GND	Open									
Open	Open	Open									
V _{CC1}	T and 5 V	Open									
GND	GND	Open									
Open	Open	12 V									
Open	Open	GND									
V _{CC1}	Т	12 V									
V _{CC1}	Т	GND									
VCC1	Т	Open									

Figure 3. Input Resistance



 TEST TABLE

 T
 VCC1
 VCC2

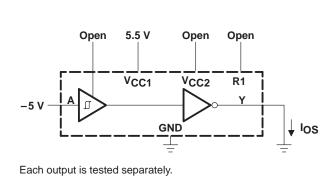
 Open
 5.5 V
 Open

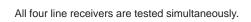
 VCC1
 5.5 V
 Open

 Open
 Open
 13.2 V

 VCC1
 T
 13.2 V

Figure 4. Input Voltage (Open)





V_{CC1}

I_{CC1}

Open



Figure 6. Supply Current

GND

13.2 V

Open

R1

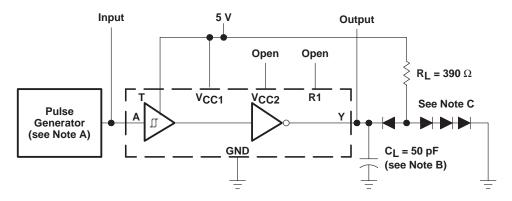
Open

I_{CC2}

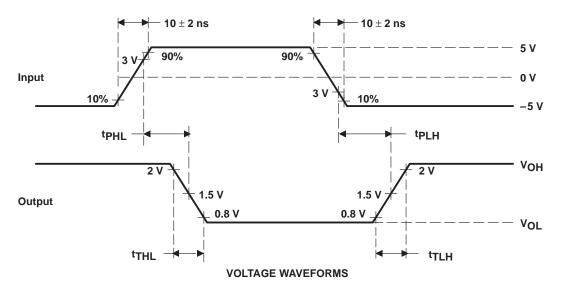
V_{CC2}

[†] Arrows indicate actual direction of current flow. Current into a terminal is a positive value.

PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT



NOTES: A. The pulse generator has the following characteristics: Z_O = 50 Ω , $t_W \le 200$ ns, duty cycle $\le 20\%$.

- B. C_L includes probe and jig capacitance.
- C. All diodes are 1N3064.

Figure 6. Test Circuit and Voltage Waveforms

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i.com 4-Jun-2007

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN75154D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75154DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75154DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75154DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75154DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75154DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75154N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN75154NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN75154NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75154NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75154NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

(1) The marketing status values are defined as follows:

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NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

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PACKAGE OPTION ADDENDUM

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TAPE AND REEL INFORMATION





Α	0	Dimension designed to accommodate the component width
В	0	Dimension designed to accommodate the component length
		Dimension designed to accommodate the component thickness
٧	٧	Overall width of the carrier tape
ГР	1	Pitch between successive cavity centers

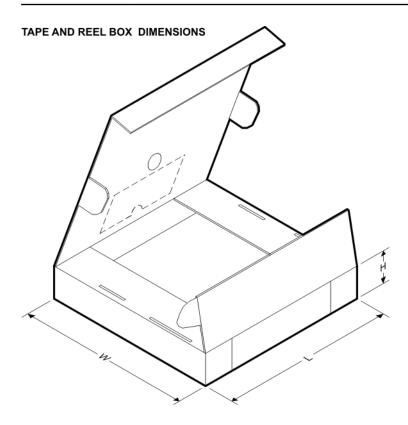
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN75154DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN75154NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1





*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN75154DR	SOIC	D	16	2500	333.2	345.9	28.6
SN75154NSR	SO	NS	16	2000	346.0	346.0	33.0

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE

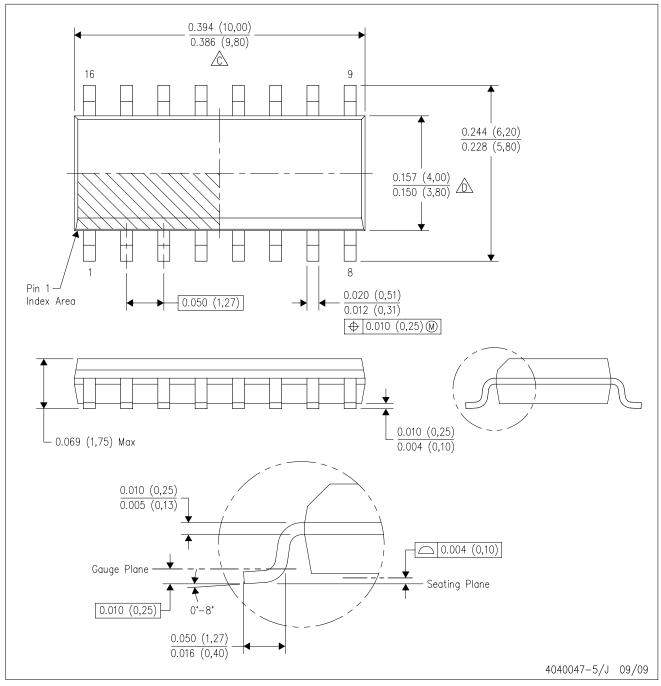


- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



D (R-PDS0-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AC.



D(R-PDSO-G16)



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Refer to IPC7351 for alternate board design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC—7525
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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